



STP80NF03L-04

STB80NF03L-04 STB80NF03L-04-1

N-CHANNEL 30V - 0.0035 Ω - 80A D²PAK/I²PAK/TO-220

STripFET™ II POWER MOSFET

| TYPE | V _{DSS} | R _{D(on)} | I _D |
|------------------|------------------|--------------------|----------------|
| STB80NF03L-04/-1 | 30 V | <0.004 Ω | 80 A |
| STB80NF03L-04 | 30 V | <0.004 Ω | 80 A |

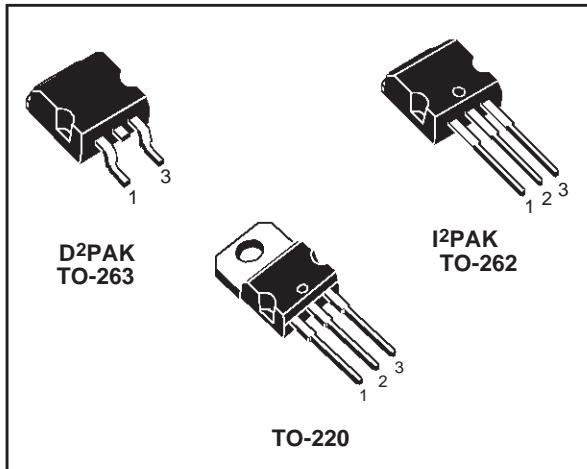
- TYPICAL R_{D(on)} = 0.0035 Ω
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- LOW THRESHOLD DRIVE

DESCRIPTION

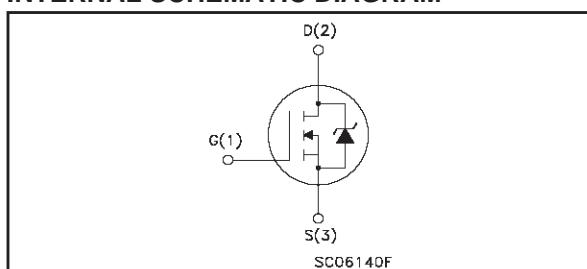
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- MOTOR CONTROL, AUDIO AMPLIFIERS
- DC-DC & DC-AC CONVERTERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)



INTERNAL SCHEMATIC DIAGRAM



Ordering Information

| SALES TYPE | MARKING | PACKAGE | PACKAGING |
|-----------------|--------------|--------------------|-------------|
| STB80NF03L-04 | 80NF03L-04 @ | D ² PAK | TUBE |
| STB80NF03L-04T4 | 80NF03L-04 @ | D ² PAK | TAPE & REEL |
| STP80NF03L-04 | 80NF03L-04 @ | TO-220 | TUBE |
| STB80NF03L-04-1 | 80NF03L-04 @ | I ² PAK | TUBE |

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|---------------------|---|------------|-----------------|
| V _{DS} | Drain-source Voltage (V _{GS} = 0) | 30 | V |
| V _{DGR} | Drain-gate Voltage (R _{GS} = 20 k Ω) | 30 | V |
| V _{GS} | Gate-source Voltage | ± 16 | V |
| I _D (*) | Drain Current (continuos) at T _C = 25°C | 80 | A |
| I _D (**) | Drain Current (continuos) at T _C = 100°C | 80 | A |
| I _{DM} (•) | Drain Current (pulsed) | 320 | A |
| P _{tot} | Total Dissipation at T _C = 25°C | 300 | W |
| | Derating Factor | 2 | W/ $^{\circ}$ C |
| dv/dt (1) | Peak Diode Recovery voltage slope | 2 | V/ns |
| E _{AS} (2) | Single Pulse Avalanche Energy | 2.3 | J |
| T _{stg} | Storage Temperature | -60 to 175 | °C |
| T _j | Max. Operating Junction Temperature | 175 | °C |

(*) Pulse width limited by safe operating area.

(**) Current Limited by Package

(1) I_{SD} ≤ 80A, di/dt ≤ 240A/ μ s, V_{DD} ≤ 24V, T_j ≤ T_{JMAX}

(2) Starting T_j = 25 °C, I_D = 40A, V_{DD} = 20V

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THERMAL DATA

| | | | | |
|---|---|-------------------|--------------------|--------------------|
| R _{thj-case} R _{thj-amb} T _I | Thermal Resistance Junction-case Thermal Resistance Junction-ambient Maximum Lead Temperature For Soldering Purpose | Max Max Typ | 0.5 62.5 300 | °C/W °C/W °C |
|---|---|-------------------|--------------------|--------------------|

ELECTRICAL CHARACTERISTICS ($T_{case} = 25^\circ\text{C}$ unless otherwise specified)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------|---|---|------|------|---------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | I _D = 250 μA V _{GS} = 0 | 30 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating V _{DS} = Max Rating T _C = 125°C | | | 1 10 | μA μA |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ± 16 V | | | ±100 | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|---|------|-----------------|-----------------|--------|
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} I _D = 250 μA | 1 | | | V |
| R _{DS(on)} | Static Drain-source On Resistance | V _{GS} = 10 V I _D = 40 A V _{GS} = 4.5 V I _D = 40 A | | 0.0035 0.004 | 0.004 0.0055 | Ω Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|---|---|------|---------------------|------|----------------|
| g _{fs} (*) | Forward Transconductance | V _{DS} = 15 V I _D = 15 A | | 50 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25V, f = 1 MHz, V _{GS} = 0 | | 5500 1670 290 | | pF pF pF |

ELECTRICAL CHARACTERISTICS (continued)**SWITCHING ON**

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------|--|---|------|----------------|------|----------------|
| $t_{d(on)}$ t_r | Turn-on Delay Time Rise Time | $V_{DD} = 15 \text{ V}$ $I_D = 40 \text{ A}$ $R_G = 4.7 \Omega$ $V_{GS} = 4.5 \text{ V}$ (Resistive Load, Figure 3) | | 30 270 | | ns ns |
| Q_g Q_{gs} Q_{gd} | Total Gate Charge Gate-Source Charge Gate-Drain Charge | $V_{DD} = 24 \text{ V}$ $I_D = 80 \text{ A}$ $V_{GS} = 4.5 \text{ V}$ | | 85 23 40 | 110 | nC nC nC |

SWITCHING OFF

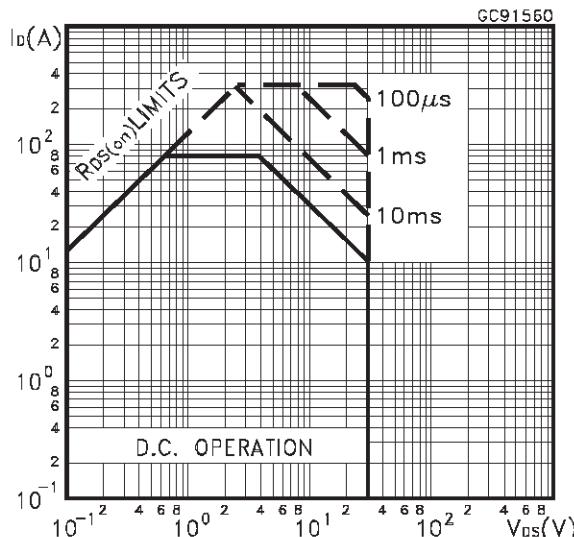
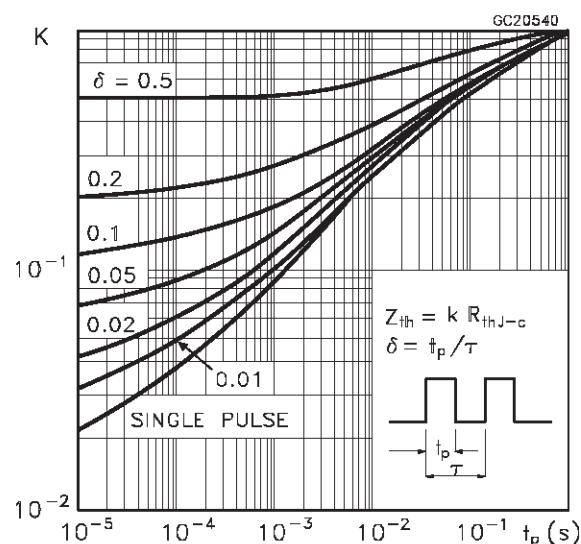
| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------------------|---|--|------|------------------|------|----------------|
| $t_{d(off)}$ t_f | Turn-off Delay Time Fall Time | $V_{DD} = 15 \text{ V}$ $I_D = 40 \text{ A}$ $R_G = 4.7 \Omega$, $V_{GS} = 4.5 \text{ V}$ (Resistive Load, Figure 3) | | 110 95 | | ns ns |
| $t_{r(voff)}$ t_f t_c | Off-Voltage Rise Time Fall Time Cross-over Time | $V_{clamp} = 24 \text{ V}$ $I_D = 80 \text{ A}$ $R_G = 4.7 \Omega$ $V_{GS} = 4.5 \text{ V}$ (Inductive Load, Figure 5) | | 125 75 125 | | ns ns ns |

SOURCE DRAIN DIODE

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|--|--|------|-----------------|-----------|--------------------------|
| I_{SD} $I_{SDM} (\bullet)$ | Source-drain Current Source-drain Current (pulsed) | | | | 80 320 | A A |
| $V_{SD} (\bullet)$ | Forward On Voltage | $I_{SD} = 80 \text{ A}$ $V_{GS} = 0$ | | | 1.5 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current | $I_{SD} = 80 \text{ A}$ $di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 20 \text{ V}$ $T_j = 150^\circ\text{C}$ (see test circuit, Figure 5) | | 75 0.15 4 | | ns μC A |

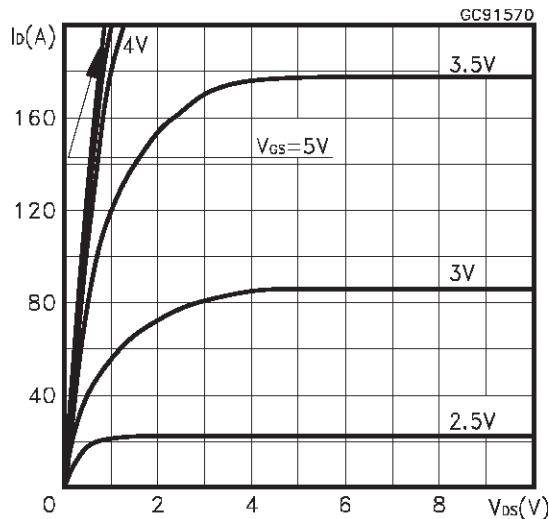
(*)Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %.

(\bullet)Pulse width limited by safe operating area.

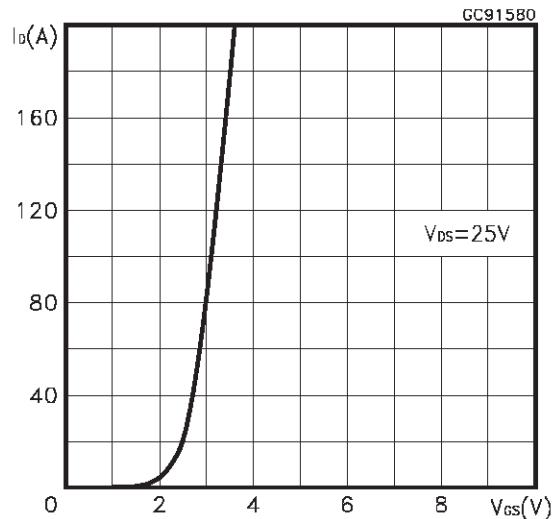
Safe Operating Area**Thermal Impedance**

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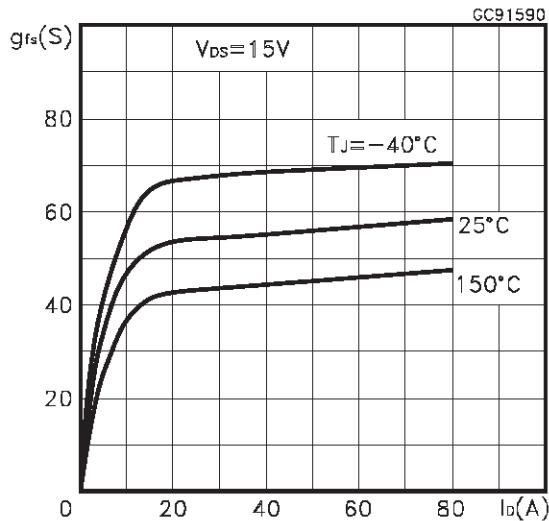
Output Characteristics



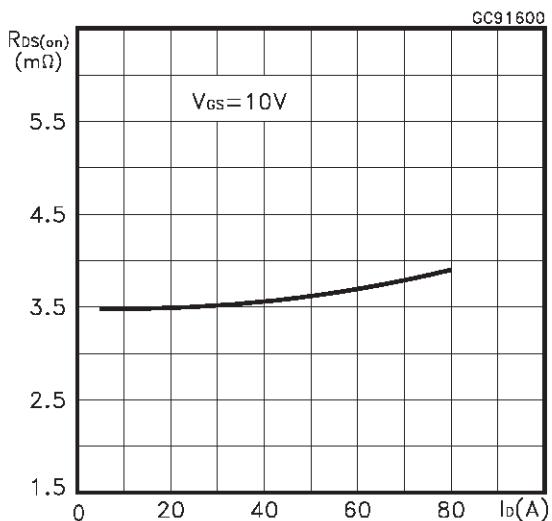
Transfer Characteristics



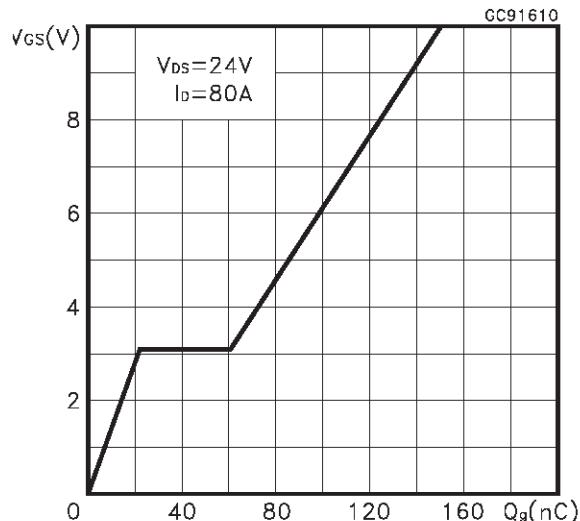
Transconductance



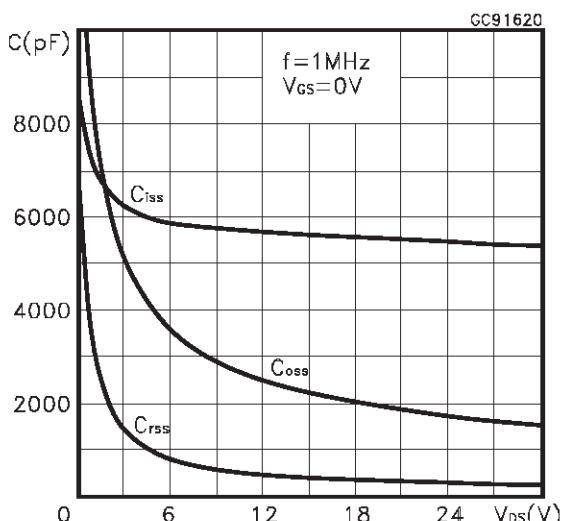
Static Drain-source On Resistance



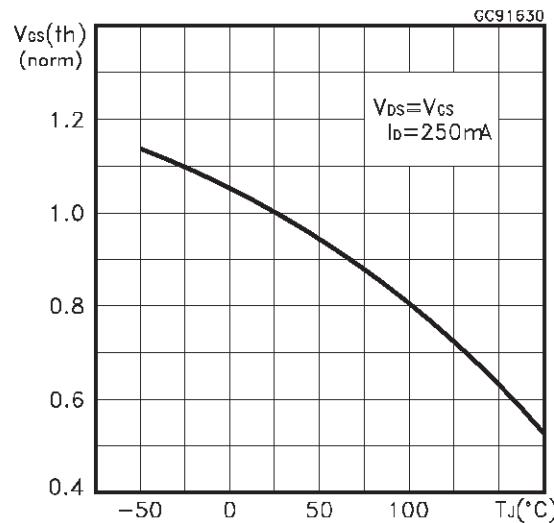
Gate Charge vs Gate-source Voltage



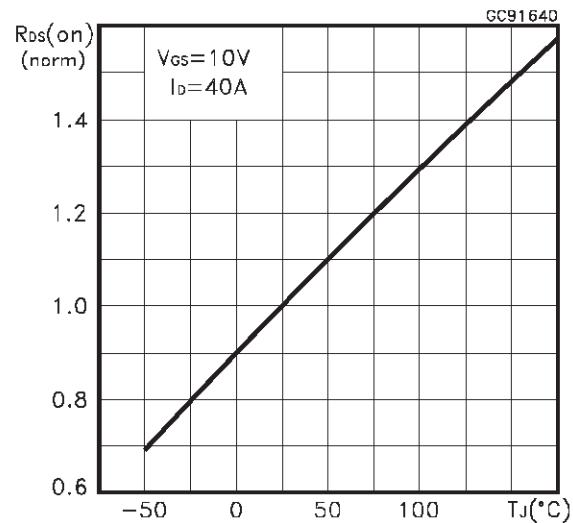
Capacitance Variations



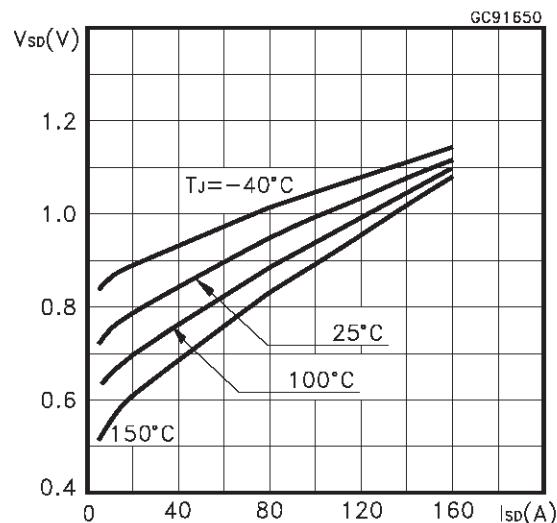
Normalized Gate Threshold Voltage vs Temperature



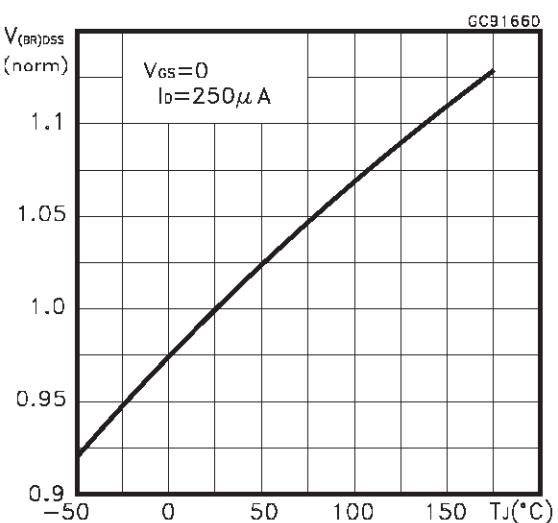
Normalized on Resistance vs Temperature



Source-drain Diode Forward Characteristics



Normalized Breakdown Voltage vs Temperature.



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Fig. 1: Unclamped Inductive Load Test Circuit

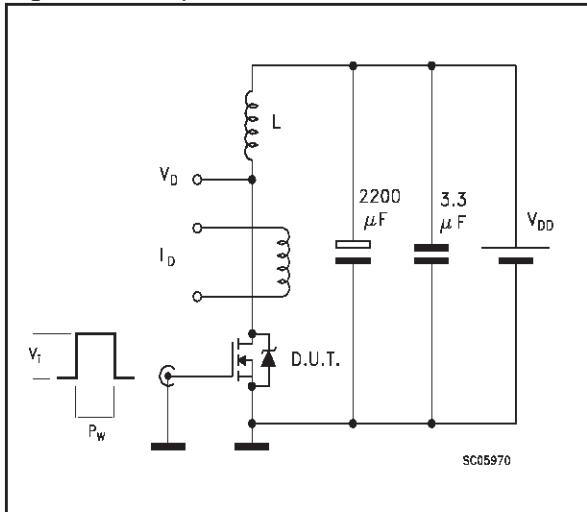


Fig. 2: Unclamped Inductive Waveform

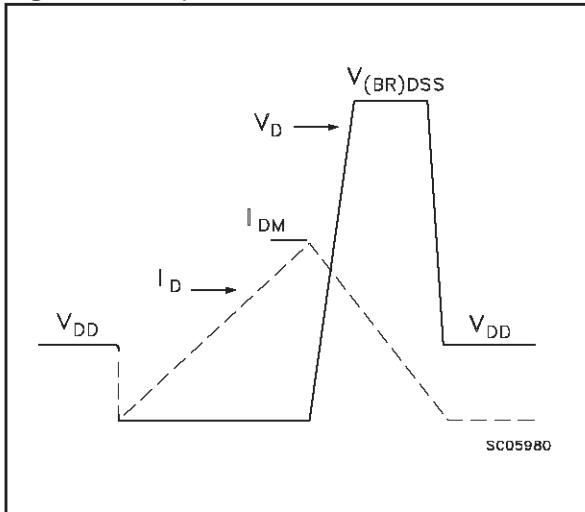


Fig. 3: Switching Times Test Circuits For Resistive Load

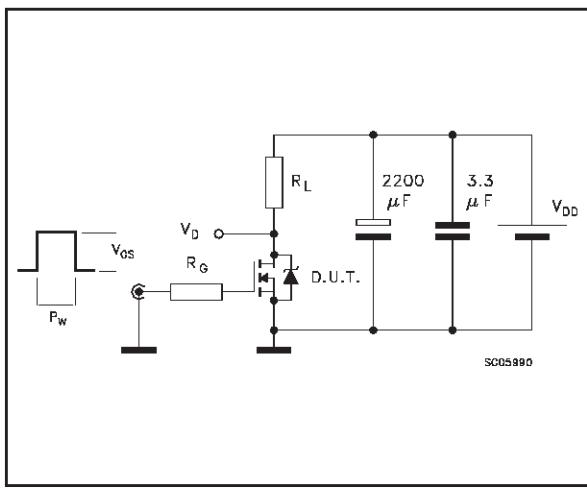


Fig. 4: Gate Charge test Circuit

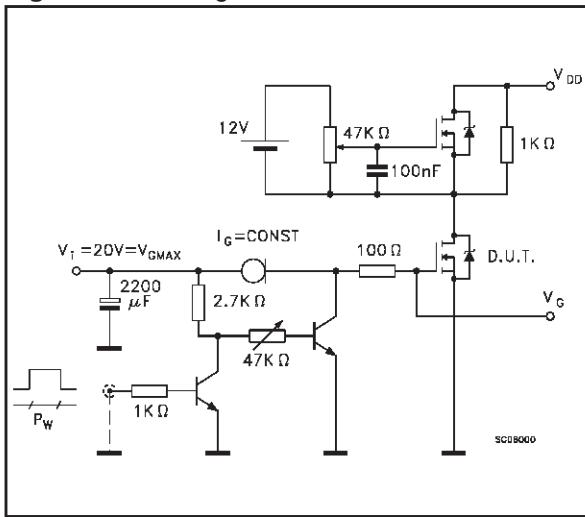
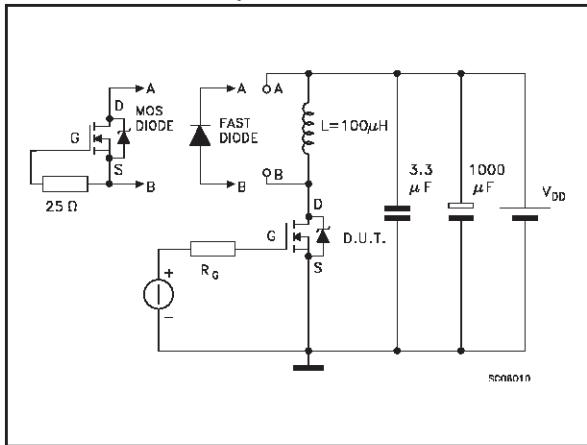
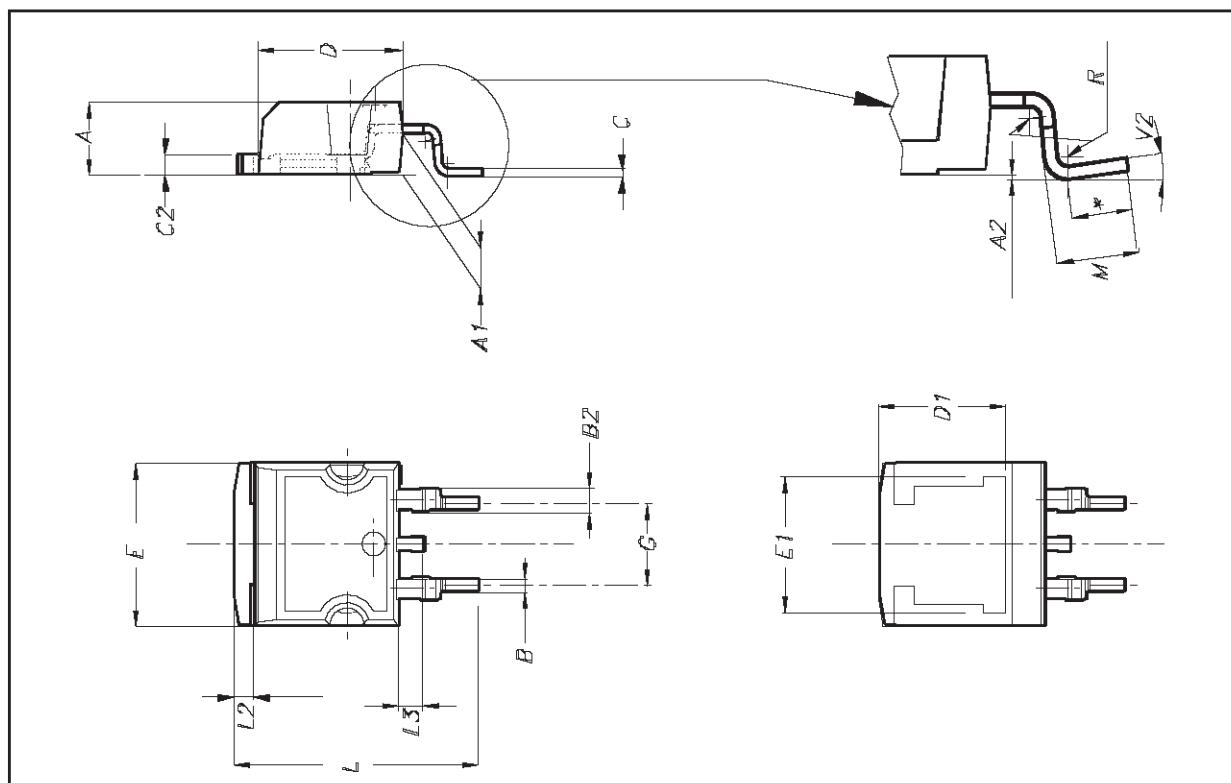


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times



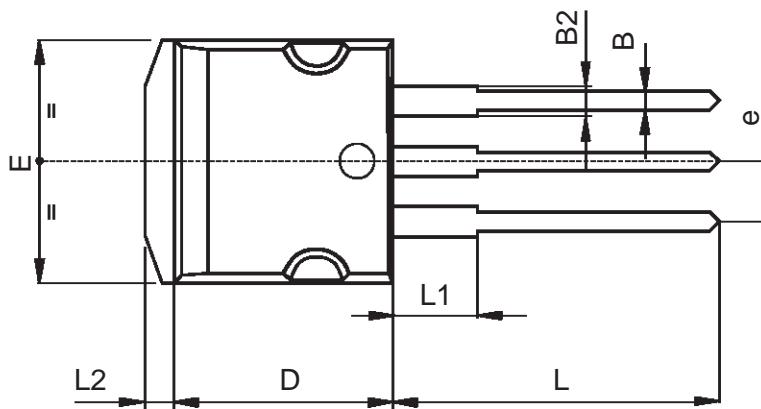
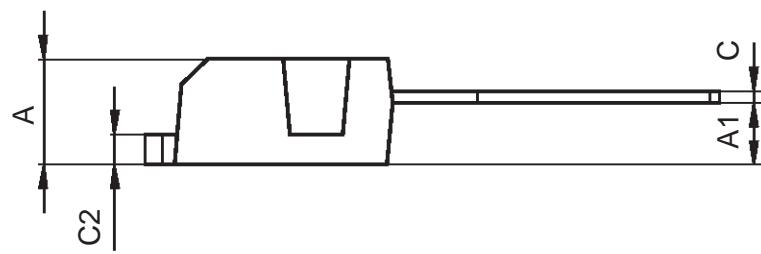
D²PAK MECHANICAL DATA

| DIM. | mm. | | | inch. | | |
|------|------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | TYP. |
| A | 4.4 | | 4.6 | 0.173 | | 0.181 |
| A1 | 2.49 | | 2.69 | 0.098 | | 0.106 |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.009 |
| B | 0.7 | | 0.93 | 0.028 | | 0.037 |
| B2 | 1.14 | | 1.7 | 0.045 | | 0.067 |
| C | 0.45 | | 0.6 | 0.018 | | 0.024 |
| C2 | 1.21 | | 1.36 | 0.048 | | 0.054 |
| D | 8.95 | | 9.35 | 0.352 | | 0.368 |
| D1 | | 8 | | | 0.315 | |
| E | 10 | | 10.4 | 0.394 | | 0.409 |
| E1 | 8.5 | | | | 0.334 | |
| G | 4.88 | | 5.28 | 0.192 | | 0.208 |
| L | 15 | | 15.85 | 0.591 | | 0.624 |
| L2 | 1.27 | | 1.4 | 0.050 | | 0.055 |
| L3 | 1.4 | | 1.75 | 0.055 | | 0.069 |
| M | 2.4 | | 3.2 | 0.094 | | 0.126 |
| R | | 0.4 | | | 0.016 | |
| V2 | 0° | | 8° | 0° | | 8° |



TO-262 (I²PAK) MECHANICAL DATA

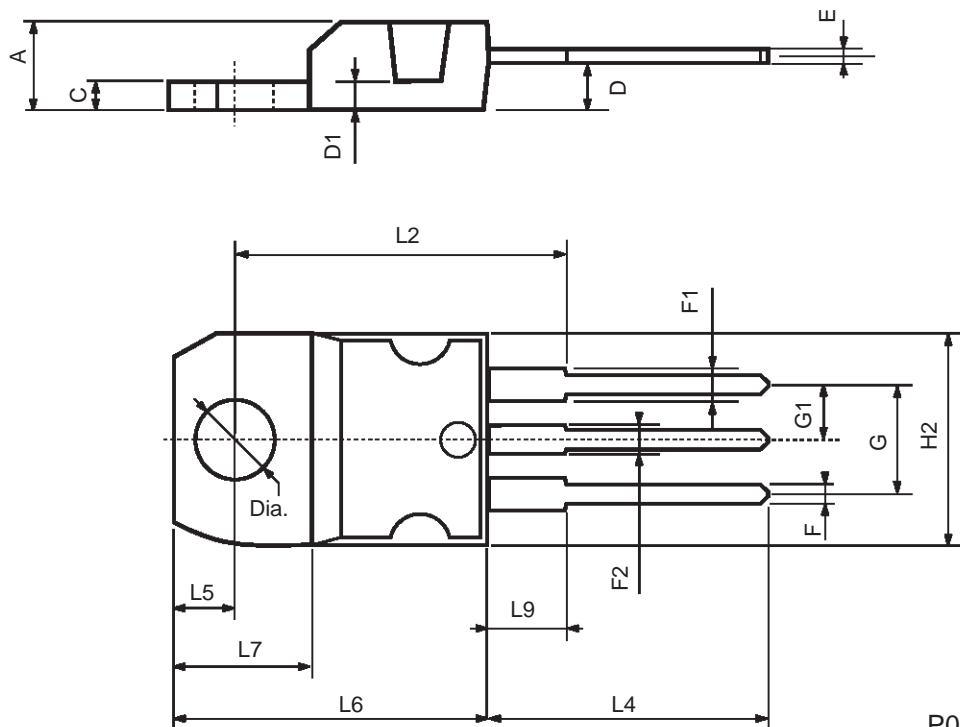
| DIM. | mm | | | inch | | |
|------|------|------|------|-------|------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.4 | | 4.6 | 0.173 | | 0.181 |
| A1 | 2.49 | | 2.69 | 0.098 | | 0.106 |
| B | 0.7 | | 0.93 | 0.027 | | 0.036 |
| B2 | 1.14 | | 1.7 | 0.044 | | 0.067 |
| C | 0.45 | | 0.6 | 0.017 | | 0.023 |
| C2 | 1.23 | | 1.36 | 0.048 | | 0.053 |
| D | 8.95 | | 9.35 | 0.352 | | 0.368 |
| e | 2.4 | | 2.7 | 0.094 | | 0.106 |
| E | 10 | | 10.4 | 0.393 | | 0.409 |
| L | 13.1 | | 13.6 | 0.515 | | 0.531 |
| L1 | 3.48 | | 3.78 | 0.137 | | 0.149 |
| L2 | 1.27 | | 1.4 | 0.050 | | 0.055 |



P011P5/E

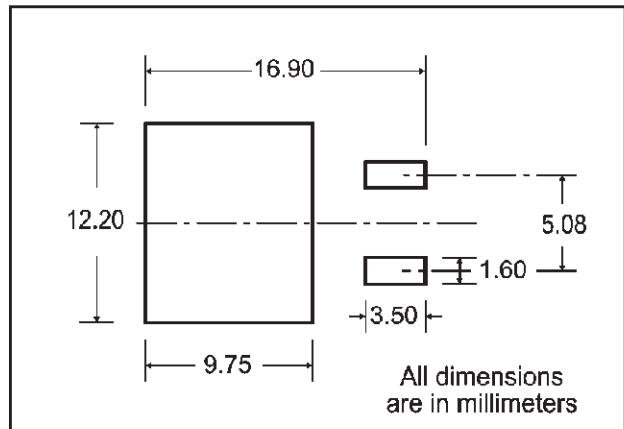
TO-220 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|-------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| C | 1.23 | | 1.32 | 0.048 | | 0.051 |
| D | 2.40 | | 2.72 | 0.094 | | 0.107 |
| D1 | | 1.27 | | | 0.050 | |
| E | 0.49 | | 0.70 | 0.019 | | 0.027 |
| F | 0.61 | | 0.88 | 0.024 | | 0.034 |
| F1 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| F2 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| G | 4.95 | | 5.15 | 0.194 | | 0.203 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| H2 | 10.0 | | 10.40 | 0.393 | | 0.409 |
| L2 | | 16.4 | | | 0.645 | |
| L4 | 13.0 | | 14.0 | 0.511 | | 0.551 |
| L5 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| L6 | 15.25 | | 15.75 | 0.600 | | 0.620 |
| L7 | 6.2 | | 6.6 | 0.244 | | 0.260 |
| L9 | 3.5 | | 3.93 | 0.137 | | 0.154 |
| DIA. | 3.75 | | 3.85 | 0.147 | | 0.151 |

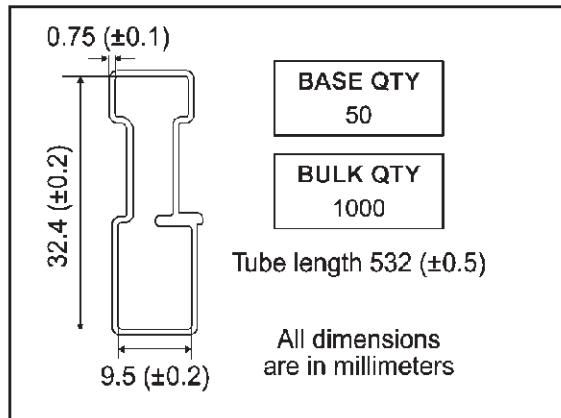


P011C

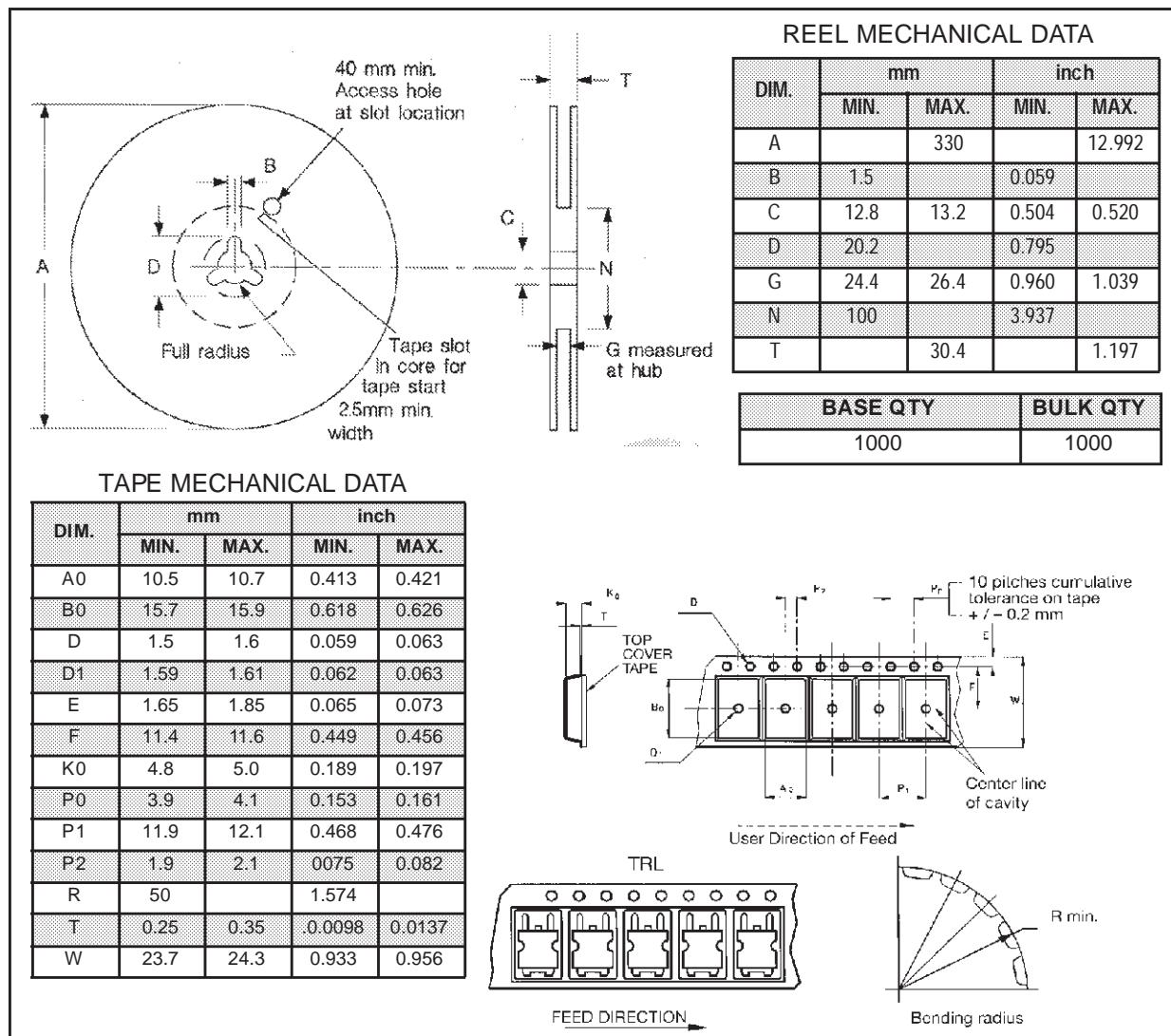
D²PAK FOOTPRINT



TUBE SHIPMENT (no suffix)*



TAPE AND REEL SHIPMENT (suffix "T4")*



* on sales type

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